Tyrone Camarero Specifications



Camerero: SDI300A2N-224

Key Feature

2U CloudDC with DC-MHS, 24 hot-swap 2.5" NVMe/SATA/SAS bays, 6 PCle 5.0 x16/x8 slots and 2 PCIe 5.0 x16 AIOM slots

Networking Appliance, Data Center Optimized, Value laaS, Cloud Computing, HPC, Data CenterPrivate & Hybrid Cloud, Cloud Solution Provider (CSP)

- Designed for Data Center Modular Hardware Systems (DC-MHS) to simplify CSP deployments and serviceability
- Optimized power & balanced performance for cloud applications
- Server management flexibility with OpenBMC
- Dual Socket E2 (LGA-4710), Intel® Xeon® 6700 series processors with E-cores, Up to 144C/144T; Up to 108MB Cache per CPU

Note: Supports up to 350W TDP CPUs (Air Cooled)

- 32 DIMM slots, Max Memory (1DPC): Up to 2TB 6400MT/s ECC DDR5 RDIMM, Max Memory (2DPC): Up to 4TB 5200MT/s ECC DDR5 RDIMM
- 4 PCle 5.0 x16 (in x16) FHFL slots, 1 PCle 5.0 x8 (in x16) FHFL slot Option A: 2 PCle 5.0 x16 (in x16) FHFL slots, 1 PCle 5.0 x8 (in x16) FHFL slot
- Total 24 bays: 24 front hot-swap 2.5" NVMe*/SAS*/SATA* drive bays M.2: 2 M.2 PCIe 5.0 x2 NVMe slots (M-key 22110(default)/2280; VROC required for RAID)
- 4x 8cm heavy duty fans with optimal fan speed control
- 2x 2000W Redundant (1 + 1) Titanium Level (96%) power supplies





Processor/Cache

Dual Socket E2 (LGA-4710), Intel® Xeon® 6700 **Processor**

series processors with E-cores, Up to 144C/144T; Up to 108MB Cache per CPU Note: Supports up to 350W TDP CPUs (Air

Cooled)

Chipset

Chipset System on Chip (SoC)

System Memory

Memory Capacity 32 DIMM slots, Max Memory (1DPC): Up to 2TB 6400MT/s ECC DDR5

RDIMM.

Max Memory (2DPC): Up to 4TB 5200MT/s ECC DDR5 RDIMM

Expansion Slot

PCI-Express

4 PCle 5.0 x16 (in x16) FHFL slots, 1 PCle 5.0

x8 (in x16) FHFL slot

Option A: 2 PCle 5.0 x16 (in x16) FHFL slots,

1 PCle 5.0 x8 (in x16) FHFL slot

Integrated Onboard:

NVMe

NVMe; RAID 0/1/5/10 support(VROC HW key required)

Add-on Options

Raid Card

None

Optical

None

Drive

Front Panel

LAN 1 RJ45 1 GbE Dedicated BMC LAN port

USB 1 USB 3.0 Type-A port(Rear), 1 USB 2.0

Type-A port(Rear)

Video 1 VGA port(Rear)

TPM 1 TPM header

Drive bays

HDD Bays 24 front hot-swap 2.5"

> NVMe*/SAS*/SATA* drive bays M.2:2 M.2 PCle 5.0 x2 NVMe slots

Power Supply

Power Supply

2x 2000W Redundant (1 + 1) Titanium

Level (96%) power supplies

Cooling System

4x 8cm heavy duty fans with optimal fan speed control

Form Factor

Form Factor

2U Rackmount

Dimensions

Dimensions

Height: 3.47" (88 mm), Width: 17.25" (438 mm), Depth: 30.7" (780 mm)

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